

## DKE CO.,LTD

EPD Module User Manual

DEPG0213RWS800F13



## Specification for 2.13 inch EPD

Model NO.: DEPG0213RWS800F13

### **DKE's Confirmation:**

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## Customer approval:

| Customer | Approved by | Date |
|----------|-------------|------|
|          |             |      |
|          |             |      |



### **Revision History**

| Version | Content                             | Date       | Producer |
|---------|-------------------------------------|------------|----------|
| 1.0     | New release                         | 2019/04/03 |          |
| 1.1     | Updata Mechanical Specification     | 2019/6/12  |          |
| 1.2     | Updata the module partial parameter | 2019/7/30  |          |
|         |                                     |            |          |
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#### 1. Over View

DEPG0213RWS800F13 is an Active Matrix Electrophoretic Display (AM EPD), with interface and a reference system design. The display is capable to display images at 1-bit white, black and red full display capabilities. The 2.13inch active area contains 250×122 pixels. The module is a TFT-array driving electrophoresis display, with integrated circuits including gate driver, source driver, MCU interface, timing controller, oscillator, DC-DC, SRAM, LUT, VCOM. Module can be used in portable electronic devices, such as Electronic Shelf Label (ESL) System.

#### 2. Features

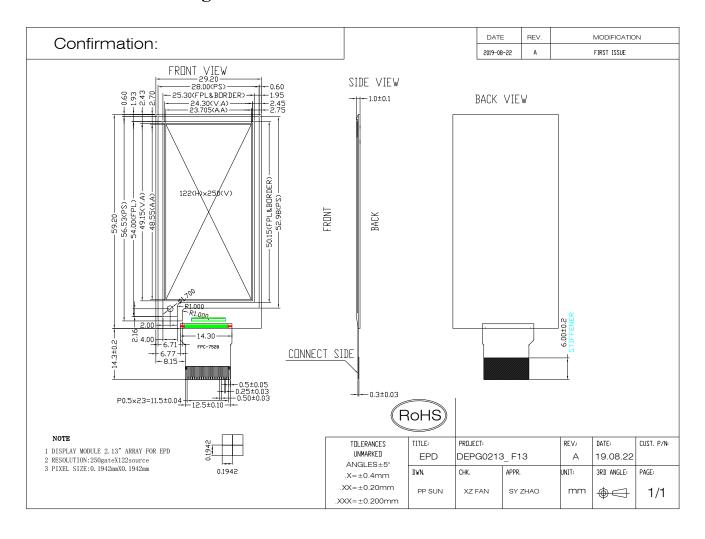
- ♦250×122 pixels display
- ◆ High contrast High reflectance
- ◆Ultra wide viewing angle Ultra low power consumption
- ◆Pure reflective mode
- ◆Bi-stable display
- ◆Commercial temperature range
- ◆Landscape portrait modes
- ◆ Hard-coat antiglare display surface
- ◆Ultra Low current deep sleep mode
- ◆On chip display RAM
- ◆ Waveform can stored in On-chip OTP or written by MCU
- ◆ Serial peripheral interface available
- ◆On-chip oscillator
- ◆On-chip booster and regulator control for generating VCOM, Gate and Source driving voltage
- ◆I<sup>2</sup>C signal master interface to read external temperature sensor
- ◆Built-in temperature sensor

### 3. Mechanical Specification

| Parameter           | Specifications           | Unit  | Remark  |
|---------------------|--------------------------|-------|---------|
| Screen Size         | 2.13                     | Inch  |         |
| Display Resolution  | 122(H)×250(V)            | Pixel | DPI:130 |
| Active Area         | 23.705×48.55             | mm    |         |
| Pixel Pitch         | 0.1942×0.1942            | mm    |         |
| Pixel Configuration | Square                   |       |         |
| Outline Dimension   | 29.2(H)×59.2 (V) ×1.0(D) | mm    |         |
| Weight              | 3.2±0.5                  | g     |         |



## 4. Mechanical Drawing of EPD Module







## 5. Input/output Pin Assignment

| No. | Name  | I/O     | Description  | Remark    |
|-----|-------|---------|--|-----------|
| 1   | NC    |         | Do not connect with other NC pins  | Keep Open |
| 2   | GDR   | О       | N-Channel MOSFET Gate Drive Control  |           |
| 3   | RESE  | I       | Current Sense Input for the Control Loop   |           |
| 4   | NC    | NC      | Do not connect with other NC pins  | Keep Open |
| 5   | VSH2  | С       | Positive Source driving voltage(Red)   |           |
| 6   | TSCL  | О       | I2C Interface to digital temperature sensor Clock pin  |           |
| 7   | TSDA  | I/O     | I2C Interface to digital temperature sensor Data pin   |           |
| 8   | BS1   | I       | Bus Interface selection pin  | Note 5-5  |
| 9   | BUSY  | О       | Busy state output pin  | Note 5-4  |
| 10  | RES#  | I       | Reset signal input. Active Low.  | Note 5-3  |
| 11  | D/C#  | I       | Data /Command control pin  | Note 5-2  |
| 12  | CS#   | Ī       | Chip select input pin  | Note 5-1  |
| 13  | SCL   | )) I \( | Serial Clock pin (SPI)   | St.       |
| 14  | SDA   | I       | Serial Data pin (SPI)  |           |
| 15  | VDDIO | P       | Power Supply for interface logic pins It should be connected with VCI  |           |
| 16  | VCI   | P       | Power Supply for the chip  |           |
| 17  | VSS   | P       | Ground   |           |
| 18  | VDD   | С       | Core logic power pin VDD can be regulated internally from VCI. A capacitor should be connected between VDD and VSS |           |
| 19  | VPP   | P       | FOR TEST   | Keep Open |
| 20  | VSH1  | С       | Positive Source driving voltage  |           |
| 21  | VGH   | С       | Power Supply pin for Positive Gate driving voltage and VSH1  |           |
| 22  | VSL   | C       | Negative Source driving voltage  |           |
| 23  | VGL   | С       | Power Supply pin for Negative Gate driving voltage VCOM and VSL  |           |
| 24  | VCOM  | C       | VCOM driving voltage   |           |





- I = Input Pin, O = Output Pin, /O = Bi-directional Pin (Input/output), P = Power Pin, C = Capacitor Pin
- Note 5-1: This pin (CS#) is the chip select input connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW.
- Note 5-2: This pin is (D/C#) Data/Command control pin connecting to the MCU in 4-wire SPI mode. When the pin is pulled HIGH, the data at SDA will be interpreted as data. When the pin is pulled LOW, the data at SDA will be interpreted as command.
- Note 5-3: This pin (RES#) is reset signal input. The Reset is active low.
- Note 5-4: This pin is Busy state output pin. When Busy is High, the operation of chip should not be interrupted, command should not be sent. The chip would put Busy pin High when -Outputting display waveform -Communicating with digital temperature sensor

Note 5-5: Bus interface selection pin

| BS1 State | MCU Interface  |
|-----------|--|
| L         | 4-lines serial peripheral interface(SPI) - 8 bits SPI  |
| Н         | 3- lines serial peripheral interface(SPI) - 9 bits SPI |

### 6. Electrical Characteristics

### 6.1 Absolute Maximum Rating

| Parameter                | Symbol | Rating           | Unit |
|--------------------------|--------|------------------|------|
| Logic supply voltage     | VCI    | -0.5 to +4.0     | V    |
| Logic Input voltage      | VIN    | -0.5 to VCI +0.5 | V    |
| Logic Output voltage     | VOUT   | -0.5 to VCI +0.5 | V    |
| Operating Temp range     | TOPR   | 0 to +40         | °C.  |
| Storage Temp range       | TSTG   | -25 to+40        | °C.  |
| Optimal Storage Temp     | TSTGo  | 23±2             | °C.  |
| Optimal Storage Humidity | HSTGo  | 55±10            | %RH  |

#### Note:

Maximum ratings are those values beyond which damages to the device may occur. Functional operation should be restricted to the limits in the Panel DC Characteristics tables.

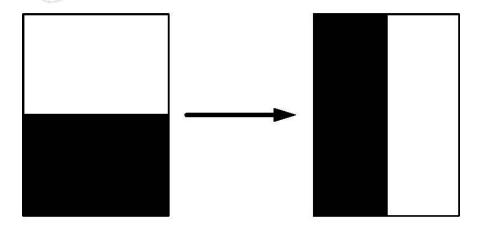


### **6.2 Panel DC Characteristics**

The following specifications apply for: VSS=0V, VCI=3.0V, TOPR =23°C.

| Parameter                 | Symbol            | Condition   | Applicab<br>le pin | Min.    | Тур.  | Max.                | Unit |
|---------------------------|-------------------|---|--------------------|---------|-------|---------------------|------|
| Single ground             | Vss               | -   |                    | -       | 0     | -                   | V    |
| Logic supply voltage      | Vci               | -   | VCI                | 2.2     | 3.0   | 3.7                 | V    |
| Core logic voltage        | $V_{\mathrm{DD}}$ |   | VDD                | 1.7     | 1.8   | 1.9                 | V    |
| High level input voltage  | Vih               | -   | -                  | 0.8 Vci | -     | -                   | V    |
| Low level input voltage   | VIL               | -   | -                  | -       | -     | 0.2 Vci             | V    |
| High level output voltage | Voh               | IOH = -100uA  | -                  | 0.9 Vci | -     | -                   | V    |
| Low level output voltage  | Vol               | IOL = 100uA   | -                  | -       | -     | 0.1 Vci             | V    |
| Typical power             | PTYP              | Vci =3.0V   | -                  | -       | 9.0   | -                   | mW   |
| Deep sleep mode           | PSTPY             | V <sub>CI</sub> =3.0V                                     | -                  | -       | 0.003 | Control of the last | mW   |
| Typical operating current | Iopr_VCI          | V <sub>CI</sub> =3.0V                                     | -                  | -       | 3.0   | 1                   | mA   |
| Image update time         | -                 | 23 °C   | Comment            | ((-)    | 14    | }} - \\             | sec  |
| Sleep mode current        | Islp_Vcı          | DC/DC off<br>No clock<br>No input load<br>Ram data retain | Ne Ne              |         | 20    |                     | uA   |
| Deep sleep mode current   | Idslp_Vci         | DC/DC off No clock No input load Ram data not retain      |                    | T-I     | AN    | 5                   | uA   |

Notes: 1. The typical power is measured with following transition from horizontal 2 scale pattern to vertical 2 scale pattern.



- 2. The deep sleep power is the consumed power when the panel controller is in deep sleep mode.
- 3. The listed electrical/optical characteristics are only guaranteed under the controller & waveform provided by DKE.



### 6.3 Panel DC Characteristics(Driver IC Internal Regulators)

The following specifications apply for: VSS=0V, VCI=3.0V, TOPR =23°C.

| Parameter                      | Symbol | Condition | Applicable pin | Min.  | Тур. | Max.  | Unit |
|--------------------------------|--------|-----------|----------------|-------|------|-------|------|
| VCOM output voltage            | VCOM   | -         | VCOM           | -     | TBD  | -     | V    |
| Positive Source output voltage | Vsh    | -         | S0~S121        | +14.5 | +15  | +15.5 | V    |
| Negative Source output voltage | Vsl    | -         | S0~S121        | -15.5 | -15  | -14.5 | V    |
| Positive gate output voltage   | Vgh    | -         | G0~G249        | +21   | +22  | +23   | V    |
| Negative gate output voltage   | Vgl    | -         | G0~G249        | -21   | -20  | -19   | V    |

#### **6.4 Panel AC Characteristics**

#### 6.4.1 MCU Interface Selection

The pin assignment at different interface mode is summarized in Table 6-4-1. Different MCU mode can be set by hardware selection on BS1 pins. The display panel only supports 4-wire SPI or 3-wire SPI interface mode.

| Pin Name         | Data/Comm | and Interface | e Control Signal |             |      |
|------------------|-----------|---------------|------------------|-------------|------|
| Bus interface    | SDA       | SCL           | CS#              | D/C#        | RES# |
| BS1=L 4-wire SPI | SDA       | SCL           | CS#              | D/C#        | RES# |
| BS1=H 3-wire SPI | SDA       | SCL           | CS#              | 7     r5p n | RES# |

### 6.4.2 MCU Serial Interface (4-wire SPI)

The serial interface consists of serial clock SCL, serial data SDA, D/C#, CS#. This interface supports Write mode and Read mode.

| Function      | CS# | D/C# | SCL |
|---------------|-----|------|-----|
| Write command | L   | L    | 1   |
| Write data    | L   | Н    | 1   |

Note: ↑ stands for rising edge of signal

In the write mode SDA is shifted into an 8-bit shift register on every rising edge of SCL in the order of D7, D6, ... D0. The level of D/C# should be kept over the whole byte. The data byte in the shift register is written to the Graphic Display Data RAM /Data Byte register or command Byte register according to D/C# pin.

CS#

D/C#

SCL

SDA (Write Mode)

D7 D6 D5 D4 D3 D2 D1 D0 W

Figure 6-1: Write procedure in 4-wire SPI mode

#### In the Read mode:

1. After driving CS# to low, MCU need to define the register to be read.

Register

- 2. SDA is shifted into an 8-bit shift register on every rising edge of SCL in the order of D7, D6, ... D0 with D/C# keep low.
- 3. After SCL change to low for the last bit of register, D/C# need to drive to high.
- 4. SDA is shifted out an 8-bit data on every falling edge of SCL in the order of D7, D6, ... D0.
- 5. Depending on register type, more than 1 byte can be read out. After all byte are read, CS# need to drive to high to stop the read operation.

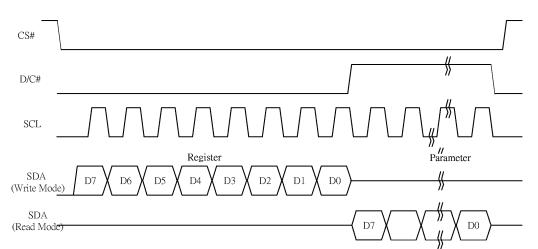


Figure 6-2: Read procedure in 4-wire SPI mode



#### **6.4.3 MCU Serial Interface (3-wire SPI)**

The 3-wire serial interface consists of serial clock SCL, serial data SDA and CS#. This interface also supports Write mode and Read mode.

The operation is similar to 4-wire serial interface while D/C# pin is not used. There are altogether 9-bits will be shifted into the shift register on every ninth clock in sequence: D/C# bit, D7 to D0 bit. The D/C# bit (first bit of the sequential data) will determine the following data byte in the shift register is written to the Display Data RAM (D/C# bit = 1) or the command register (D/C# bit = 0).

| Function      | CS# | D/C# | SCL |
|---------------|-----|------|-----|
| Write command | L   | Tie  | 1   |
| Write data    | L   | Tie  | 1   |

Note: ↑ stands for rising edge of signal

SDA (Write Mode)

Register

Register

CS#

SCL

SDA (Write Mode)

Register

Parameter

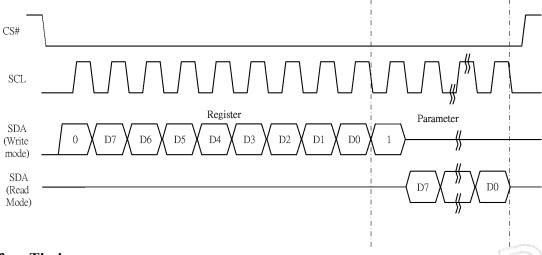
Figure 6-3: Write procedure in 3-wire SPI mode

#### In the Read mode:

- 1. After driving CS# to low, MCU need to define the register to be read.
- 2. D/C=0 is shifted thru SDA with one rising edge of SCL
- 3. SDA is shifted into an 8-bit shift register on every rising edge of SCL in the order of D7, D6, ... D0.
- 4. D/C=1 is shifted thru SDA with one rising edge of SCL
- 5. SDA is shifted out an 8-bit data on every falling edge of SCL in the order of D7, D6, ... D0.
- 6. Depending on register type, more than 1 byte can be read out. After all byte are read, CS# need to drive to high to stop the read operation.

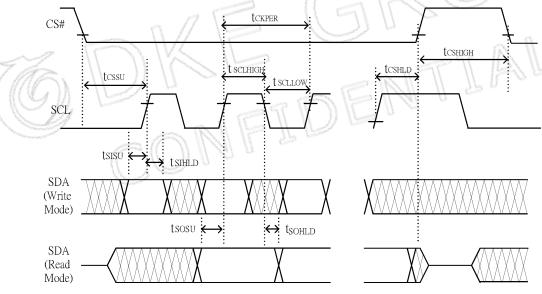


Figure 6-4: Read procedure in 3-wire SPI mode



### **6.4.4 Interface Timing**

The following specifications apply for: VSS=0V, VCI=3.0V, TOPR =23°C.



**Changed Diagram** 



### **Serial Interface Timing Characteristics**

 $(VCI - VSS = 2.2V \text{ to } 3.7V, TOPR = 23^{\circ}C, CL=20pF)$ 

#### Write mode

| Symbol   | Parameter  | Min | Тур. | Max | Unit |
|----------|--|-----|------|-----|------|
| fSCL     | SCL frequency (Write Mode)   |     |      | 20  | MHz  |
| tCSSU    | Time CS# has to be low before the first rising edge of SCLK                  | 60  |      |     | ns   |
| tCSHLD   | Time CS# has to remain low after the last falling edge of SCLK               | 20  |      |     | ns   |
| tCSHIGH  | Time CS# has to remain high between two transfers                            | 100 |      |     | ns   |
| tSCLHIGH | Part of the clock period where SCL has to remain high                        | 25  |      |     | ns   |
| tSCLLOW  | Part of the clock period where SCL has to remain low                         | 25  | 7    | 10  | ns   |
| tSISU    | Time SI (SDA Write Mode) has to be stable before the next rising edge of SCL | 10  |      | 1   | ns   |
| tSIHLD   | Time SI (SDA Write Mode) has to remain stable after the rising edge of SCL   | 40  |      |     | ns   |
| Read mod | de la                                    | A   |      |     |      |

| Wheel of     |  | 177 | 11   |     |      |
|--------------|--|-----|------|-----|------|
| Symbol       | Parameter  | Min | Тур. | Max | Unit |
| fSCL         | SCL frequency (Read Mode)  |     |      | 2.5 | MHz  |
| tCSSU        | Time CS# has to be low before the first rising edge of SCLK              | 100 |      |     | ns   |
| tCSHLD       | Time CS# has to remain low after the last falling edge of SCLK           | 50  |      |     | ns   |
| tCSHIGH      | Time CS# has to remain high between two transfers                        | 250 |      |     | ns   |
| tSCLHIG<br>H | Part of the clock period where SCL has to remain high                    | 180 |      |     | ns   |
| tSCLLOW      | Part of the clock period where SCL has to remain low                     | 180 |      |     | ns   |
| tSOSU        | Time SO(SDA Read Mode) will be stable before the next rising edge of SCL |     | 50   |     | ns   |
| tSOHLD       | Time SO (SDA Read Mode) will remain stable after the rising edge of SCL  |     | 0    |     | ns   |



### 7. Command Table

| /.0  | OIIII | 11411 | u  | av |    |    |     |    |            |       |  |  |
|------|-------|-------|----|----|----|----|-----|----|------------|-------|--|--|
| R/W# | D/C#  | Hex   | D7 | D6 | D5 | D4 | D3  | D2 | D1         | D0    | Comman<br>d  | Description  |
| 0    | 0     | 01    | 0  | 0  | 0  | 0  | 0   | 0  | 0          | 1     | Driver   | Gate setting   |
| 0    | 1     |       | A7 | A6 | A5 | A4 | A3  | A2 | A1         | A0    | Output   | Set A[8:0]=0097h   |
| 0    | 1     |       | 0  | 0  | 0  | 0  | 0   | 0  | 0          | A8    | control  | Set B[8:0]=00h   |
| 0    | 1     |       | 0  | 0  | 0  | 0  | 0   | B2 | B1         | В0    |  |  |
| 0    | 0     | 03    | 0  | 0  | 0  | 0  | 0   | 0  | 1          | 1     | Gate   | SetGate Driving voltage  |
| 0    | 1     |       | 0  | 0  | 0  | A4 | A3  | A2 | <b>A</b> 1 | A0    | Driving voltage                                    | A[4:0]=17h[POR],VGH at 20V[POR]<br>VGH setting from 10V to 20V   |
|      |       |       |    |    |    |    |     |    |            |       | control  |  |
| 0    | 0     | 04    | 0  | 0  | 0  | 0  | 0   | 1  | 0          | 0     | Source   | SetSource Driving voltage  |
| 0    | 1     |       | A7 | A6 | A5 | A4 | A3  | A2 | A1         | A0    | Driving  | A[7:0]= 41h[POR],VSH1 at 15V   |
| 0    | 1     |       | В7 | В6 | В5 | B4 | В3  | В2 | B1         | В0    | voltage<br>control                                 | B[7:0]=A Ch[POR], VSH2 at 5.4V<br>C[7:0]= 32h[POR], VSL at -15V  |
| 0    | 1     |       | C7 | C6 | C5 | C4 | C3  | C2 | C1         | C0    | Control  | 52m[1 GR], V 52 ut 13 V  |
| 0    | 0     | 08    | 0  | 0  | 0  | 0  | 1   | 0  | 0          | 0     | Initial<br>Code<br>Setting<br>OTP<br>Program       | Program Initial Code Setting The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation   |
| 0    | 0     | 09    | 0  | 0  | 0  | 0  | 1\1 | 0  | 0          | 1\    | Write  | Write Register for Initial Code Setting  |
| 0    | 1     |       | A7 | A6 | A5 | A4 | A3  | A2 | A1         | A0    | Register   | Selection  |
| 0    | 1     |       | В7 | B6 | B5 | B4 | В3  | B2 | B1         | В0    | Code   | A[7:0] ~ D[7:0]: Reserved<br>Details refer to Application Notes of Initial   |
| 0    |       | 1     | C7 | C6 | C5 | C4 | C3  | C2 | C1         | C0    | Setting  | Code Setting   |
| 0    | Y,    | V).   | D7 | D6 | D5 | D4 | D3  | D2 | D1         | D0    | 71/=   | May a  |
| 0    | 0     | 0A    | 0  | 0  | 0  | 0  |     | 0  | 1          | 0     | Read<br>Register<br>for Initial<br>Code<br>Setting | Read Register for Initial Code Setting   |
| 0    | 0     | 10    | 0  | 0  | 0  | 1  | 0   | 0  | 0          | 0     | Deep   | Deep Sleep mode Control:   |
| 0    | 1     |       | 0  | 0  | 0  | 0  | 0   | 0  | 0          | $A_0$ | Sleep<br>mode                                      | A[1:0]: Description 00 Normal Mode [POR] 01 Enter Deep Sleep Mode 1 11 Enter Deep Sleep Mode 2 After this command initiated, the chip will enter Deep Sleep Mode, BUSY pad will keep output high. Remark: To Exit Deep Sleep mode, User required to send HWRESET to the driver |



| 0 | 0 | 11 | 0 | 0 | 0 | 1 | 0 | 0              | 0  | 1              | Entry<br>mode<br>setting | Define data entry sequence A[2:0] = 011 [POR] A [1:0] = ID[1:0] Address automatic increment / decrement setting The setting of incrementing or decrementing of the address counter can be made independently in each upper and  |
|---|---|----|---|---|---|---|---|----------------|----|----------------|--------------------------|---|
| 0 | 1 |    | 0 | 0 | 0 | 0 | 0 | A <sub>2</sub> | Aı | A <sub>0</sub> |                          | lower bit of the address.  00 - Y decrement, X decrement,  01 - Y decrement, X increment,  10 - Y increment, X decrement,  11 - Y increment, X increment [POR]  A[2] = AM  Set the direction in which the address counter is updated automatically after data are written to the RAM.  AM= 0, the address counter is updated in the X direction. [POR]  AM = 1, the address counter is updated in the Y direction |
|   | Ć |    |   |   |   |   |   |                |    |                | DE                       | NTIAL   |



|               |      |     |    |  |      |      |      |      |     |      | 1  |  |
|---------------|------|-----|----|--|------|------|------|------|-----|------|--|--|
| 0             | 0    | 0C  | 0  | 0  | 0    | 0    | 1    | 1    | 0   | 0    | Booster  | Booster Enable with Phase 1, Phase 2 and Phase 3 |
|               |      |     |    |  |      |      |      |      |     |      |  | for soft start current and duration setting.     |
|               |      |     |    |  |      |      |      |      |     |      | Control  | A[7:0] -> Soft start setting for Phase1          |
|               |      |     |    |  |      |      |      |      |     |      |  | = 8Bh [POR]                                      |
|               |      |     |    |  |      |      |      |      |     |      |  | B[7:0] -> Soft start setting for Phase2          |
|               |      |     |    |  |      |      |      |      |     |      |  | = 9Ch [POR]                                      |
|               |      |     |    |  |      |      |      |      |     |      |  | C[7:0] -> Soft start setting for Phase3          |
|               |      |     |    |  |      |      |      |      |     |      |  | = 96h [POR]                                      |
|               |      |     |    |  |      |      |      |      |     |      |  | D[7:0] -> Duration setting                       |
|               |      |     |    |  |      |      |      |      |     |      |  | = 0Fh [POR]                                      |
|               |      |     |    |  |      |      |      |      |     |      |  | Bit Description of each byte:                    |
|               |      |     |    |  |      |      |      |      |     |      |  | A[6:0] / B[6:0] / C[6:0]:                        |
|               |      |     |    |  |      |      |      |      |     |      |  | Bit[6:4]   |
|               |      |     |    |  |      |      |      |      |     |      |  | Driving Strength                                 |
|               |      |     |    |  |      |      |      |      |     |      |  | Selection  |
|               |      |     |    |  |      |      |      |      |     |      |  | 000 1(Weakest)                                   |
|               |      |     |    |  |      |      |      |      |     |      |  | 001 2  |
|               |      |     |    |  |      |      |      |      |     |      |  | 010 3  |
|               |      |     |    |  |      |      |      |      |     |      |  | 011 4  |
|               |      |     |    |  |      |      |      |      |     |      |  | 100 5  |
|               |      |     |    |  |      |      |      |      |     |      |  | 101 6  |
|               |      |     |    |  |      |      |      |      |     |      | and the same of the same   | 110 7  |
|               |      |     |    |  |      |      |      |      |     | ,    | 1  | 111 8(Strongest)                                 |
|               |      |     |    |  |      |      |      |      |     | - {  | ( =1   | Bit[3:0]   |
|               |      |     |    |  |      | 17   | 1    |      | 7   | /    | 1 -1   | Min Off Time Setting of GDR                      |
|               |      |     |    | and the same of the same   | 1/   |      | \    | (    |     |      | A CONTRACTOR OF THE PARTY OF TH | [ Time unit ]                                    |
|               | ~_7  |     | 1  | 1  | 1/   |      | \    |      | -   |      |  | 0000   |
| " The same of | 68 > |     | \\ | )  | 1    |      | 0    |      |     |      |  |  |
| 1//           |      | 1/1 | \\ | 1  | / \  | 7)   |      |      |     |      | S  | 0011   |
| 1 1/          | S    | //) | 10 | Control of the Contro |      |      |      |      | 653 | 77 0 |  | NA   |
| / //          | C2   |     |    |  |      |      |      | 15   | = 1 |      | 11 1   | 0100 2.6   |
| -             |      |     |    |  | 1    | 1    | 13   | 1 /5 |     | 1 6  |  | 0101 3.2   |
|               |      |     |    | 17   | -((_ | - }} | 1/3/ | 1 1  |     |      |  | 0110 3.9   |
| 0             | 1    |     | 1  | A6   | A5   | A4   | A3   | A2   | A1  | A0   |  | 0111 4.6   |
| 0             | 1    |     | 1  | В6   | B5   | B4   | В3   | B2   | B1  | В0   |  | 1000 5.4   |
|               |      |     |    |  |      |      |      |      |     |      | -  | 1001 6.3   |
| 0             | 1    |     | 1  | C6   | C5   | C4   | C3   | C2   | C1  | C0   |  | 1010 7.3   |
| 0             | 1    |     | 0  | 0  | D5   | D4   | D3   | D2   | D1  | D0   | 1  | 1011 8.4   |
|               | 1    |     |    | <u> </u>   |      | J-T  | 23   | 22   | 101 | 20   | _  | 1100 9.8   |
|               |      |     |    |  |      |      |      |      |     |      |  | 1101 11.5  |
|               |      |     |    |  |      |      |      |      |     |      |  | 1110 13.8  |
|               |      |     |    |  |      |      |      |      |     |      |  | 1111 16.5  |
|               |      |     |    |  |      |      |      |      |     |      |  | D[5:0]: duration setting of phase                |
|               |      |     |    |  |      |      |      |      |     |      |  | D[5:4]: duration setting of phase 3              |
|               |      |     |    |  |      |      |      |      |     |      |  | D[3:2]: duration setting of phase 2              |
|               |      |     |    |  |      |      |      |      |     |      |  | D[1:0]: duration setting of phase 1              |
|               |      |     |    |  |      |      |      |      |     |      |  | Bit[1:0]   |
|               |      |     |    |  |      |      |      |      |     |      |  | Duration of Phase                                |
|               |      |     |    |  |      |      |      |      |     |      |  | [Approximation]                                  |
|               |      |     |    |  |      |      |      |      |     |      |  | 00 10ms  |
|               |      |     |    |  |      |      |      |      |     |      |  | 01 20ms  |
|               |      |     |    |  |      |      |      |      |     |      |  | 10 30ms  |
|               |      |     |    |  |      |      |      |      |     |      |  |  |
| 1             |      |     |    |  |      |      | ĺ    |      |     |      | 1  | 11 40ms  |



| 0 | 0    | 12  | 0  | 0  | 0  | 1  | 0  | 0  | 1  | 0  | SWRES<br>ET   | It resets the commands and parameters to their S/W Reset default values except R10h-Deep Sleep Mode During operation, BUSY pad will output high.  Note: RAM are unaffected by this command.   |
|---|------|-----|----|----|----|----|----|----|----|----|---|---|
| 0 | 0    | 18  | 0  | 0  | 0  | 1  | 1  | 0  | 0  | 0  | _   | Temperature Sensor Selection  |
| 0 | 1    |     | A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 | ure<br>Sensor<br>Control                              | A[7:0] = 48h [POR], external temperature sensor<br>A[7:0] = 80h Internal temperature sensor   |
| 0 | 0    | 1A  | 0  | 0  | 0  | 1  | 1  | 0  | 1  | 0  | Temperat  | Write to temperature register.  |
| 0 | 1    |     | A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 | ure<br>Sensor   | A[11:0] = 7FFh [POR]  |
| 0 | 1    |     | В7 | В6 | B5 | B4 | 0  | 0  | 0  | 0  | Control<br>(Write to<br>temperat<br>ure<br>register)l | - OIIP  |
| 0 | 0    | 20  | 0  | 0  | 1  | 0  | 0  | 0  | 0  | 0  | Master<br>Activatio<br>n                              | Activate Display Update Sequence The Display Update Sequence Option is located at R22h User should not interrupt this operation to avoid corruption of panel images.  |
| 0 | 0    | 21  | 0  | 0  | 1  | 0  | 0  | 0  | 0  | 1  | Display   | RAM content option for Display Update   |
| 0 | (Vi) | 1/1 | A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 | Update  | A[7:0] = 00h [POR]  |
| 0 |      |     | B7 | 0  | 0  | 0  | 0  | 0  | 0  | 0  | Control 1   | B[7:0] = 00h [POR] A[7:4] Red RAM option 0000 Normal 0100 Bypass RAM content as 0 1000 Inverse RAM content A[3:0] BW RAM option 0000 Normal 0100 Bypass RAM content as 0 1000 Inverse RAM content B[7] Source Output Mode 0 Available Source from S0 to S175 1 Available Source from S8 to S167 |



|       |                       | 22   |    |              |        |      |       |         |     |      | D: ,                  |  |
|-------|-----------------------|------|----|--------------|--------|------|-------|---------|-----|------|-----------------------|--|
| 0     | 0                     | 22   | 0  | 0            | 1      | 0    | 0     | 0       | 1   | 0    |                       | Display Update Sequence Option:        |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable the stage for Master Activation |
|       |                       |      |    |              |        |      |       |         |     |      |                       | A[7:0] = FFh (POR)                     |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Operating sequence                     |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Parameter                              |
|       |                       |      |    |              |        |      |       |         |     |      |                       | (in Hex)                               |
|       |                       |      |    |              |        |      |       |         |     |      | 1                     | Enable clock signal 80                 |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable clock signal 01                |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable clock signal                    |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable Analog                          |
|       |                       |      |    |              |        |      |       |         |     |      |                       | -                                      |
|       |                       |      |    |              |        |      |       |         |     |      | 1                     | C0                                     |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable Analog                         |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable clock signal                   |
|       |                       |      |    |              |        |      |       |         |     |      |                       | 03                                     |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable clock signal                    |
|       |                       |      |    |              |        |      |       |         |     |      | 4                     | Load LUT with DISPLAY Mode 1           |
| 0     | 1                     |      | A7 | A6           | A5     | A4   | A3    | A2      | A1  | A0   |                       | Disable clock signal                   |
|       |                       |      |    |              |        |      |       |         |     |      |                       | 91                                     |
|       |                       |      |    |              |        |      |       |         |     |      |                       | 1 1000                                 |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable clock signal                    |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Load LUT with DISPLAY Mode 2           |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable clock signal                   |
|       |                       |      |    |              |        |      |       |         |     |      | and the second second | 99                                     |
|       |                       |      |    |              |        |      |       |         |     |      | 1                     | Enable clock signal                    |
|       |                       |      |    |              |        |      |       |         |     | 1    | (-1                   | Load temperature value                 |
|       |                       |      |    |              |        | 17   | r \ 1 |         | 100 | 1    | 1 -11                 | Load LUT with DISPLAY Mode 1           |
|       |                       |      |    | e (accino    | $\Box$ | //   | \     | Carrent | 100 |      |                       | Disable clock signal                   |
|       |                       |      | 1  | and the same | 11     | /<   | \     | \       |     |      | 1                     | B1                                     |
| 400   |                       |      | \\ | \            | } \.   |      | -     | L       |     |      |                       | Enable clock signal                    |
| 1 / 1 | MF.                   | 1    | \\ |              | / \    | 1    | 1     |         |     |      |                       |  |
| 1 //  |                       | 1/1  | 1/ |              |        |      |       |         |     | -    |                       | Load temperature value                 |
| 1 //  |                       | 11/2 | 1  |              |        |      |       | 4 8400  | 5 G | P 11 | 11/15                 | Load LUT with DISPLAY Mode 2           |
| 1     |                       | Á    |    |              |        |      | 20    | 10      |     | 1    |                       | Disable clock signal                   |
|       | and the second second |      |    |              | 17     | 17   | B     | 1 1     |     | J. 1 | 1                     | B9                                     |
|       |                       |      |    | 1            | 17     | - }} | 11 %  | 7 0     |     |      |                       | Enable clock signal                    |
|       |                       |      |    | //           | 1      |      | 15.5  |         |     |      |                       | Enable Analog                          |
|       |                       |      |    | 1            |        |      |       |         |     |      |                       | Display with DISPLAY Mode 1            |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable Analog                         |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable OSC                            |
|       |                       |      |    |              |        |      |       |         |     |      |                       | C7                                     |
|       |                       |      |    |              |        |      |       |         |     |      |                       |  |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable clock signal                    |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable Analog                          |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Display with DISPLAY Mode 2            |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable Analog                         |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable OSC                            |
|       |                       |      |    |              |        |      |       |         |     |      |                       | CF                                     |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable clock signal                    |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable Analog                          |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Load temperature value                 |
|       |                       |      |    |              |        |      |       |         |     |      |                       | DISPLAY with DISPLAY Mode 1            |
|       |                       |      |    |              |        |      |       |         |     |      |                       |  |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable Analog                         |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Disable OSC                            |
|       |                       |      |    |              |        |      |       |         |     |      |                       | F7                                     |
|       |                       |      |    |              |        |      |       |         |     |      | 1                     | Enable clock signal                    |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Enable Analog                          |
|       |                       |      |    |              |        |      |       |         |     |      |                       | Load temperature value                 |



| O   | 0  | 0              | 24   | 0       | 0               | 1   | 0  | 0  | 1   | 0  | 0  | Write<br>RAM<br>(Black<br>White)<br>/ RAM<br>0x24 | After this command, data entries will be written into the BW RAM until another command is written. Address pointers will advance accordingly For Write pixel:  Content of Write RAM(BW) = 1  For Black pixel:  Content of Write RAM(BW) = 0 |
|---|----|----------------|------|---------|-----------------|-----|----|----|-----|----|----|---|---|
| 0         1         A7         A6         A5         A4         A3         A2         A1         A0         VCOM register         A[7:0] = 00h [POR]           0         0         2D         0         0         1         0         1         0         1         OTP         Read Register for Display Option: A[7:0]: VCOM OTP Selection           1         1         A7         A6         A5         A4         A3         A2         A1         A0         Register         A[7:0]: VCOM OTP Selection         (Command 0x37, Byte A)         B[7:0]: VCOM Register         A[7:0]: VCOM Register         (Command 0x37, Byte A)         B[7:0]: VCOM Register         B[7:0]: VCOM Register         (Command 0x2C)         C[7:0]~G[7:0]: Display Mode         C(T:0]~G[7:0]: Display Mode         C(T:0]~G[7:0]: Display Mode         C(T:0]~G[7:0]: Waveform Version         C(T:0]~K[7:0]: Waveform Version         [5 bytes]         H[7:0]~K[7:0]: Waveform Version         [4 bytes]           1         1         H7         H6         H5         H4         H3         H2         H1         H0         H1         H1         H1         H1         H1         H1         H1         H1         H1         H2         H1         H1         H2         H2         H2         H2         H2         H  | 0  | 0              | 26   | 0       | 0               | 1   | 0  | 0  | 1   | 1  | 0  | (RED)<br>/ RAM                                    | command is written. Address pointers will advance accordingly.  For Red pixel:  Content of Write RAM(RED) = 1  For non-Red pixel [Black or White]:  |
| 0         1         A7         A6         A5         A4         A3         A2         A1         A0         register           0         0         2D         0         0         1         0         1         0         Total Dota Date Date Date Date Date Date Date Da  | 0  | 0              | 2C   | 0       | 0               | 1   | 0  | 1  | 1   | 0  | 0  |   |   |
| 1       1       A7       A6       A5       A4       A3       A2       A1       A0       Register Read for Read for Display Option       A[7:0]: VCOM OTP Selection (Command 0x37, Byte A)       B[7:0]: VCOM Register (Command 0x37, Byte A)         1       1       D7       D6       D5       D4       D3       D2       D1       D0         1       1       D7       D6       D5       D4       D3       D2       D1       D0         1       1       E7       E6       E5       E4       E3       E2       E1       E0         1       1       F7       F6       F5       F4       F3       F2       F1       F0         1       1       G7       G6       G5       G4       G3       G2       G1       G0         1       1       H7       H6       H5       H4       H3       H2       H1       H0         1       1       17       16       15       14       13       12       11       10     Register Read for Display Option (Command 0x37, Byte A) B[7:0]: VCOM Register (Command 0x37, Byte B to Byte F) [5 bytes] H[7:0]~K[7:0]: Waveform Version (Command 0x37, Byte G to Byte J) [4 bytes] B[7:0]: VCOM OTP Selection (Command 0x37, Byte A) B[7:0]: V  | 0  | 1              |      | A7      | A6              | A5  | A4 | A3 | A2  | A1 | A0 |   | A[7:0] = 00h [POR]  |
| 1       1       B7       B6       B5       B4       B3       B2       B1       B0       Read for Display Option       (Command 0x37, Byte A)       B[7:0]: VCOM Register       B[7:0]: VCOM Register       (Command 0x2C)       C[7:0]~G[7:0]: Display Mode       C[7:0]~G[7:0]: Display Mode       (Command 0x37, Byte B to Byte F)       C[7:0]~G[7:0]: Display Mode       (Command 0x37, Byte B to Byte F)       [5 bytes]       H[7:0]~K[7:0]: Waveform Version       [6 bytes]       H[7:0]~K[7:0]: Waveform Version       (Command 0x37, Byte B to Byte F)       [6 bytes]       H[7:0]~K[7:0]: Waveform Version       (Command 0x37, Byte B to Byte F)       [6 bytes]       H[7:0]~K[7:0]: Waveform Version       (Command 0x37, Byte G to Byte J)       [6 bytes]         1 </td <td>0</td> <td>0</td> <td>2D</td> <td>0</td> <td>0</td> <td>1</td> <td>0</td> <td>1</td> <td>1</td> <td>0</td> <td>1</td> <td></td> <td></td> | 0  | 0              | 2D   | 0       | 0               | 1   | 0  | 1  | 1   | 0  | 1  |   |   |
| 1       1       B7       B6       B5       B4       B3       B2       B1       B0       Display         1       1       C7       C6       C5       C4       C3       C2       C1       C0       Option       B[7:0]: VCOM Register         1       1       D7       D6       D5       D4       D3       D2       D1       D0         1       1       E7       E6       E5       E4       E3       E2       E1       E0         1       1       F7       F6       F5       F4       F3       F2       F1       F0         1       1       G7       G6       G5       G4       G3       G2       G1       G0         1       1       H7       H6       H5       H4       H3       H2       H1       H0         1       1       17       16       15       14       13       12       11       10     Display  Option  Option  Option  Option  Display  Display  Option  Display  D  | 1  | 1              |      | A7      | A6              | A5  | A4 | A3 | A2  | A1 | A0 |   |   |
| 1       1       C7       C6       C5       C4       C3       C2       C1       C0       Option       (Command 0x2C)         1       1       D7       D6       D5       D4       D3       D2       D1       D0         1       1       E7       E6       E5       E4       E3       E2       E1       E0         1       1       F7       F6       F5       F4       F3       F2       F1       F0         1       1       G7       G6       G5       G4       G3       G2       G1       G0         1       1       H7       H6       H5       H4       H3       H2       H1       H0         1       1       17       16       15       14       13       12       11       10     (Command 0x2C)  (Command 0x37, Byte B to Byte F)  [5 bytes]  H[7:0]~K[7:0]: Waveform Version (Command 0x37, Byte G to Byte J)  [4 bytes]  [4 bytes]   | 1  | 1              |      | В7      | B6              |     | B4 |    | 100 | B1 | B0 | F   |   |
| 1       1       E7       E6       E5       E4       E3       E2       E1       E0         1       1       F7       F6       F5       F4       F3       F2       F1       F0         1       1       G7       G6       G5       G4       G3       G2       G1       G0         1       1       H7       H6       H5       H4       H3       H2       H1       H0         1       1       17       16       15       14       13       12       11       10    (Command 0x37, Byte B to Byte F) [5 bytes] H[7:0]~K[7:0]: Waveform Version (Command 0x37, Byte G to Byte J) [4 bytes] [4 bytes]  | 1  | 1              |      | C7      | C6              | C5  | C4 | C3 | C2  | C1 | C0 |   | (Command 0x2C)  |
| 1     1     F7     F6     F5     F4     F3     F2     F1     F0       1     1     G7     G6     G5     G4     G3     G2     G1     G0       1     1     H7     H6     H5     H4     H3     H2     H1     H0       1     1     1     16     15     14     13     12     11     10   [5 bytes] [H[7:0]~K[7:0]: Waveform Version (Command 0x37, Byte G to Byte J) [4 bytes] [4 bytes]  | 1  |                |      | -       | Colonia Colonia | 1.1 | // | _  | \   | D1 |    |   |   |
| 1       1       F7       F6       F5       F4       F3       F2       F1       F0         1       1       G7       G6       G5       G4       G3       G2       G1       G0         1       1       H7       H6       H5       H4       H3       H2       H1       H0         1       1       17       16       15       14       13       12       11       10    H[7:0]~K[7:0]: Waveform Version (Command 0x37, Byte G to Byte J) [4 bytes]   |    | and the second |      |         | - \             | 1 1 |    | 7  | 1   |    |    |   |   |
| 1     1     G7     G6     G5     G4     G3     G2     G1     G0       1     1     H7     H6     H5     H4     H3     H2     H1     H0       1     1     17     16     15     14     13     12     11     10   (Command 0x37, Byte G to Byte J) [4 bytes]  | 1/ | 7.135          | 11   | - 1 - 1 | 1               | ,   | F4 | F3 |     | F1 | F0 | 0   | H[7:0]~K[7:0]: Waveform Version   |
| 1 1 17 16 15 14 13 12 11 10   | 1  | Y              | 1/)_ | G7      | G6              | G5  | G4 | G3 | G2  | G1 | G0 | ME  | (Command 0x37, Byte G to Byte J)  |
|   | 1  | 1              | 4    | H7      | Н6              | H5  | H4 | Н3 | H2  | H1 | H0 | 1   | [4 bytes]   |
| 1 1 J7 J6 J5 J4 J3 J2 J1 J0   | 1  | 1              |      | I7      | I6              | 15  | I4 | I3 | I2  | I1 | 10 |   |   |
|   | 1  | 1              |      | J7      | J6              | J5  | J4 | J3 | J2  | J1 | J0 | -   |   |
| 1 1 K7 K6 K5 K4 K3 K2 K1 K0   | 1  | 1              |      | K7      | K6              | K5  | K4 | K3 | K2  | K1 | K0 | -   |   |



| 0 | 0  | 2F   | 0  | 0  | 1  | 0   | 1   | 1    | 1    | 1     | Status<br>Bit Read     | Read IC status Bit [POR 0x01] A[5]: HV Ready Detection flag [POR=0] 0: Ready 1: Not Ready A[4]: VCI Detection flag [POR=0] 0: Normal 1: VCI lower than the Detect level A[3]: [POR=0] A[2]: Busy flag [POR=0] 0: Normal 1: BUSY A[1:0]: Chip ID [POR=01] Remark: A[5] and A[4] status are not valid after RESET, they need to be initiated by command 0x14 and command 0x15 respectively |
|---|----|------|----|----|----|-----|-----|------|------|-------|------------------------|--|
| 0 | 0  | 30   | 0  | 0  | 1  | 1   | 0   | 0    | 0    | 0     | Program<br>WS OTP      | Program OTP of Waveform Setting The contents should be written into RAM before sending this command. The command required CLKEN=1. Refer to Register 0x22 for detail. BUSY pad will output high during operation   |
| 0 | 0  | 32   | 0  | 0  | 1\ | /4  | 0   | 0    | 1    | 0     | Write                  | Write LUT register from MCU interface  |
| 0 | 4- |      | A7 | A6 | A5 | A4  | A3  | A2   | A1   | A0    | LUT                    | [153 bytes], which contains the content of   |
| 0 |    | 1/1  | В7 | В6 | В5 | B4  | В3  | B2   | B1   | В0    | register               | VS[nX-LUTm], TP[nX], RP[n], SR[nXY],   |
| 0 | Ŧ, | 11), | 1  | :  | :  | :   | :   |      | 29   | 11: 9 | MIT                    | FR[n] and XON[nXY] Refer to Session 6.7 WAVEFORM   |
| 0 | T  | 9    | :  | :  | :  | - I | 1.8 | 1/2  | > \) | 1.1   |                        | SETTING  |
| 0 | 1  |      | :  | 1  | (( |     | 11  | 7 11 | : '  | :     | 1                      |  |
| 0 | 1  |      | :  | 1  | 1  |     | :   | :    | :    | :     | 1                      |  |
| 0 | 0  | 39   | 0  | 0  | 1  | 1   | 1   | 0    | 0    | 1     | OTP<br>program<br>mode | OTP program mode A[1:0] = 00: Normal Mode [POR] A[1:0] = 11: Internal generated OTP programming voltage Remark: User is required to EXACTLY follow the reference code sequences  |
| 0 | 0  | 3C   | 0  | 0  | 1  | 1   | 1   | 1    | 0    | 0     |                        | Select border waveform for VBD<br>A[7:0] = C0h [POR], set VBD as HIZ.  |



| 0  | 1                     |    | <b>A</b> <sub>7</sub> | A <sub>6</sub> | <b>A</b> <sub>5</sub> | A <sub>4</sub> | 0              | 0              | Aı             | $A_0$          |                         | A [7:6] :Select VBD option A[7:6] Select VBD as 00 GS Transition, Defined in A[2] and A[1:0] 01 Fix Level, Defined in A[5:4] 10 VCOM 11[POR] HiZ A [5:4] Fix Level Setting for VBD A[5:4] VBD level 00 VSS 01 VSH1 10 VSL 11 VSH2 A[2] GS Transition control A[2] GS Transition control 0 Follow LUT (Output VCOM @ RED) 1 Follow LUT |
|----|-----------------------|----|-----------------------|----------------|-----------------------|----------------|----------------|----------------|----------------|----------------|-------------------------|---|
|    |                       |    |                       |                |                       |                |                |                |                |                |                         | A [1:0] GS Transition setting for VBD<br>A[1:0] VBD Transition  |
|    |                       |    |                       |                |                       |                | -              |                |                | - (            |                         | 00 LUT0<br>01 LUT1  |
|    |                       |    |                       |                | П                     | 11             | 1              |                | 3              | \              |                         | 10 LUT2   |
| 0  | 0                     | 44 | 0                     | 1              | 0                     | 0              | 0              | 1              | 0              | 0              | Set RAM                 | 11 LUT3 Specify the start/end positions of the window   |
| 0  | 1/1                   | Ž. | 0                     | 0              | 0                     | $A_4$          | $A_3$          | $A_2$          | $A_1$          | $A_0$          | X -                     | address in the X direction by an address unit   |
| 0  |                       | // | 0                     | 0              | 0                     | B <sub>4</sub> | B <sub>3</sub> | $B_2$          | B <sub>1</sub> | $B_0$          | address                 | A[4:0]: XSA[4:0], X Start, POR = 00h  |
| 11 |                       |    |                       |                |                       |                | a f            | TE             | 3 1            | \              | Start /<br>End          | B[4:0]: XEA[4:0], X End, POR = 0Ch  |
|    | and the second second |    |                       |                | 1                     | 1              | M              | 1 1            | 1              | The l          | position                |   |
| 0  | 0                     | 45 | 0                     | (1             | 0                     | 0              | 0              | 1              | 0              | 1              | Set Ram                 | Specify the start/end positions of the window   |
| 0  | 1                     |    | A <sub>7</sub>        | A <sub>6</sub> | <b>A</b> <sub>5</sub> | A <sub>4</sub> | A <sub>3</sub> | A <sub>2</sub> | A <sub>1</sub> | $A_0$          | Y-<br>address           | address in the Y direction by an address unit A[8:0]: YSA[8:0], Y Start, POR = 00D3h  |
| 0  | 1                     |    | 0                     | 0              | 0                     | 0              | 0              | 0              | 0              | A <sub>8</sub> | Start /                 | B[8:0]: YEA[8:0], Y End, POR = 0000h  |
| 0  | 1                     |    | B <sub>7</sub>        | B <sub>6</sub> | B <sub>5</sub>        | B <sub>4</sub> | B <sub>3</sub> | B <sub>2</sub> | B <sub>1</sub> | $B_0$          | →                       |   |
| 0  | 1                     |    | 0                     | 0              | 0                     | 0              | 0              | 0              | 0              | $B_8$          | position                |   |
| 0  | 0                     | 4E | 0                     | 1              | 0                     | 0              | 1              | 1              | 1              | 0              |                         | Make initial settings for the RAM X address in  |
| 0  | 1                     |    | 0                     | 0              | 0                     | A <sub>4</sub> | A <sub>3</sub> | A <sub>2</sub> | A <sub>1</sub> | A <sub>0</sub> | X<br>address<br>counter | the address counter (AC)<br>A[4:0]: XAD[4:0], POR is 00h  |
| 0  | 0                     | 4F | 0                     | 1              | 0                     | 0              | 1              | 1              | 1              | 1              |                         | Make initial settings for the RAM Y address in  |
| 0  | 1                     |    | A <sub>7</sub>        | A <sub>6</sub> | $A_5$                 | $A_4$          | A <sub>3</sub> | $A_2$          | A <sub>1</sub> | $A_0$          | Y                       | the address counter (AC)  |
| 0  | 1                     |    | 0                     | 0              | 0                     | 0              | 0              | 0              | 0              | A <sub>8</sub> | address<br>counter      | A[8:0]: YAD[8:0], POR is 00D3h  |
|    |                       |    |                       |                |                       |                |                |                |                |                | Counter                 |   |



### 8. Optical Specification

Measurements are made with that the illumination is under an angle of 45 degree, the detection is perpendicular unless otherwise specified

| Symbol   | Parameter          | Conditions | Min | Тур.                   | Max | Units | Notes |
|----------|--------------------|------------|-----|------------------------|-----|-------|-------|
| R        | White Reflectivity | White      | 30  | 35                     | -   | %     | 8-1   |
| CR       | Contrast Ratio     | indoor     | 8:1 |                        | -   |       | 8-2   |
| GN       | 2Grey Level        | -          | -   | DS+(WS-DS)*n(m-1)      |     |       | 8-3   |
| T update | Image update time  | at 23 °C   | -   | 14                     | -   | sec   |       |
| Life     |                    | Topr       |     | 1000000times or 5years |     |       |       |

Notes: 8-1. Luminance meter: Eye-One Pro Spectrophotometer.

8-2. CR=Surface Reflectance with all white pixel/Surface Reflectance with all black pixels.

8-3 WS: White state, DS: Dark state

### 9. Handling, Safety, and Environment Requirements

### Warning

The display glass may break when it is dropped or bumped on a hard surface. Handle with care. Should the display break, do not touch the electrophoretic material. In case of contact with electrophoretic material, wash with water and soap.

#### Caution

The display module should not be exposed to harmful gases, such as acid and alkali gases, which corrode electronic components. Disassembling the display module.

Disassembling the display module can cause permanent damage and invalidates the warranty agreements.

Observe general precautions that are common to handling delicate electronic components. The glass can break and front surfaces can easily be damaged. Moreover the display is sensitive to static electricity and other rough environmental conditions.

| Data sheet status   |  |  |  |  |  |  |
|---|--|--|--|--|--|--|
| Product specification   | Product specification This data sheet contains final product specifications. |  |  |  |  |  |
|   | Limiting values  |  |  |  |  |  |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |  |  |  |  |  |  |
| Application information   |  |  |  |  |  |  |
| Where application information is given, it is advisory and does not form part of the specification.   |  |  |  |  |  |  |



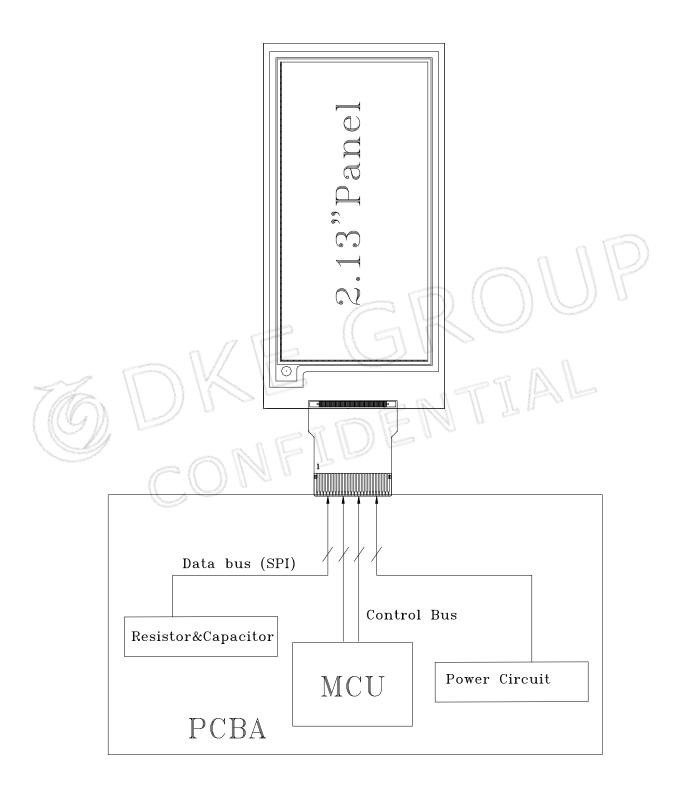
## 10. Reliability Test

| NO | Test items                                   | Test condition   |
|----|--|--|
| 1  | Low-Temperature<br>Storage                   | T = -25°C, 240 h<br>Test in white pattern  |
| 2  | High-Temperature<br>Storage                  | T=60°C, RH=40%, 240h<br>Test in white pattern  |
| 3  | High-Temperature Operation                   | T=40°C, RH=35%, 240h   |
| 4  | Low-Temperature Operation                    | 0°C, 240h  |
| 5  | High-Temperature,<br>High-Humidity Operation | T=40°C, RH=80%, 240h   |
| 6  | High Temperature, High<br>Humidity Storage   | T=50°C, RH=80%, 240h<br>Test in white pattern  |
| 7  | Temperature Cycle                            | 1 cycle:[-25°C 30min]→[+60 °C 30 min] : 50 cycles<br>Test in white pattern   |
| 8  | UV exposure Resistance                       | 765W/m² for 168hrs,40 °C<br>Test in white pattern  |
| 9  | ESD Gun                                      | Air+/-15KV;Contact+/-8KV  (Test finished product shell, not display only)  Air+/-8KV;Contact+/-6KV  (Naked EPD display, no including IC and FPC area)  Air+/-4KV;Contact+/-2KV  (Naked EPD display, including IC and FPC area) |

Note: Put in normal temperature for 1hour after test finished, display performance is ok.

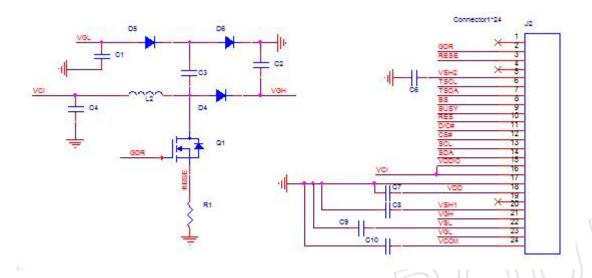


## 11. Block Diagram





## 12. Typical Application Circuit with SPI Interface

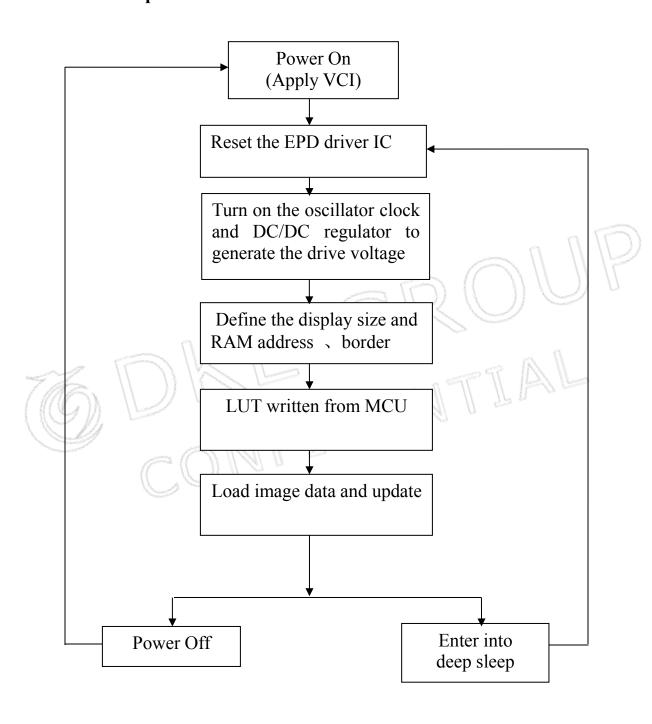


| Part Name            | Value       | Reference Part      | Requirements for spare part   |  |  |  |
|----------------------|-------------|---------------------|---|--|--|--|
| C4 C7                | 1uF         | X5R/X7R             | X5R/X7R;Voltage Rating:6v or 25v  |  |  |  |
| C1 C2 C3 C6<br>C8 C9 | 1uF         | 0402/0603/0803      | 5; X5R/X7R; Voltage Rating: 25v   |  |  |  |
| C10                  | 0.47uF/1 uF |                     | 0603/0805; X7R; Voltage Rating: 25v<br>NOTE: Effective capacitance > 0.25uF @18v DC bias                                    |  |  |  |
| R1                   | 2.2Ohm      | 0402,0603,0         | 0805; 1% variation, ≥ 0.05W   |  |  |  |
| D4 D5 D6             | Diode       | MBR0530             | <ol> <li>Reverse DC Voltage ≥ 30V</li> <li>Io≥500mA</li> <li>Forward voltage ≤ 430mV</li> </ol>                             |  |  |  |
| Q1                   | NMOS        | Si1304BDL/NX3008NBK | <ol> <li>Drain-Source breakdown voltage≥30v</li> <li>Vgs(th)=0.9v(Typ), 1.3v(Max)</li> <li>rds on≤2.1Ω@ Vgs=2.5v</li> </ol> |  |  |  |
| L2                   | 47UH        | CDRH2D18/LDNP-470NC | 1) Io=500mA(max)  |  |  |  |



## 13 Typical Operating Sequence

### 13.1Normal Operation Flow



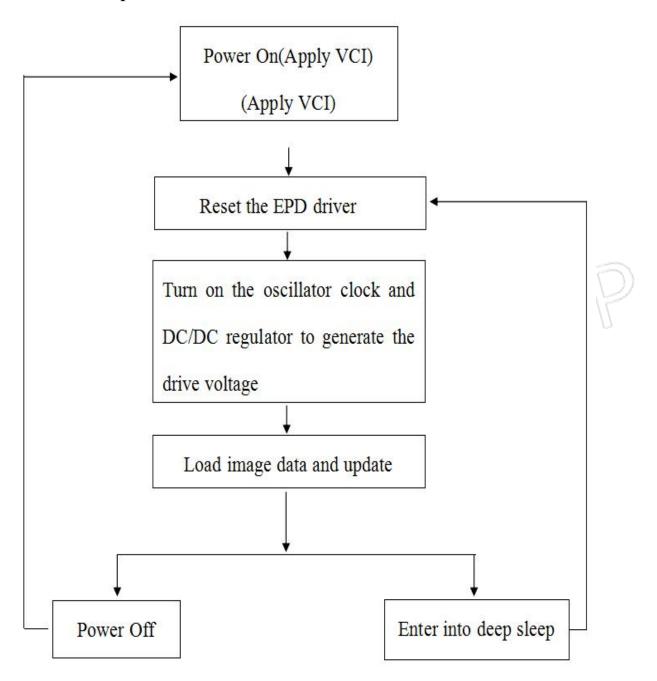


## 13.2 Normal Operation Reference Program Code

| ACTION                 | VALUE/DATA               | COMMENT                                    |  |  |  |
|------------------------|--------------------------|--|--|--|--|
| POWER ON               |                          |  |  |  |  |
| delay                  | 10ms                     |  |  |  |  |
| PIN CONFIG             |                          |  |  |  |  |
| RESE#                  | low                      | Hardware reset                             |  |  |  |
| delay                  | 200us                    |  |  |  |  |
| RESE#                  | high                     |  |  |  |  |
| delay                  | 200us                    |  |  |  |  |
| Read busy pin          |                          | Wait for busy low                          |  |  |  |
| Command 0x12           |                          | Software reset                             |  |  |  |
| Read busy pin          |                          | Wait for busy low                          |  |  |  |
| Command 0x01           | Data 0xF9 0x00 0x00      | Set display size and driver output control |  |  |  |
| Command 0x11           | Data 0x01                | Ram data entry mode                        |  |  |  |
| Command 0x44           | Data 0x01 0x10           | Set Ram X address                          |  |  |  |
| Command 0x45           | Data 0xF9 0x00 0x00 0x00 | Set Ram Y address                          |  |  |  |
| Command 0x3C Data 0x05 |                          | Set border                                 |  |  |  |
|                        | SET VOLTAGE AND L        | OAD LUT                                    |  |  |  |
| Command 0x2C           | Data 0x36                | Set VCOM value                             |  |  |  |
| Command 0x03           | Data 0x17                | Gate voltage setting                       |  |  |  |
| Command 0x04           | Data 0x41 0x00 0x32      | Source voltage setting                     |  |  |  |
| Command 0x32           | Write 153bytes LUT       | Load LUT                                   |  |  |  |
|                        | LOAD IMAGE AND U         | JPDATE                                     |  |  |  |
| Command 0x4E           | Data 0x01                | Set Ram X address counter                  |  |  |  |
| Command 0x4F           | Data 0xF9 0x00           | Set Ram Y address counter                  |  |  |  |
| Command 0x24           | 4000bytes                | Load image (128/8*250)(BW)                 |  |  |  |
| Command 0x26           | 4000bytes                | Load image (128/8*250)(RED)                |  |  |  |
| Command 0x22 Data 0XC7 |                          | Image update                               |  |  |  |
| Command 0x20           |                          |  |  |  |  |
| Read busy pin          |                          | Wait for busy low                          |  |  |  |
| Command 0x10           | Data 0X01                | Enter deep sleep mode                      |  |  |  |
|                        | POWER OFF                |  |  |  |  |



## 13.3 OTP Operation Flow





### 13.4 OTP Operation Reference Program Code

| ACTION        | VALUE/DATA         | COMMENT                     |  |  |
|---------------|--------------------|-----------------------------|--|--|
|               | POWER ON           |                             |  |  |
| delay         | 10ms               |                             |  |  |
|               | PIN CONFIG         |                             |  |  |
| RESE#         | low                | Hardware reset              |  |  |
| delay         | 200us              |                             |  |  |
| RESE#         | high               |                             |  |  |
| delay         | 200us              |                             |  |  |
| Read busy pin |                    | Wait for busy low           |  |  |
| Command 0x12  |                    | Software reset              |  |  |
| Read busy pin |                    | Wait for busy low           |  |  |
|               | SET VOLTAGE AND LO | OAD LUT                     |  |  |
|               | LOAD IMAGE AND U   | PDATE                       |  |  |
| Command 0x24  | 4000bytes          | Load image (128/8*250)(BW)  |  |  |
| Command 0x26  | 4000bytes          | Load image (128/8*250)(RED) |  |  |
| Command 0x20  |                    |                             |  |  |
| Read busy pin |                    | Wait for busy low           |  |  |
| Command 0x10  | Data 0X01          | Enter deep sleep mode       |  |  |
|               | POWER OFF          |                             |  |  |
| 6 D           | KEG                | ENTIAL                      |  |  |



### 14. Part Number Definition

#### DEP G 0213 R W S800 F13

1 2 3 4 5 6 7

1: DEP:DKE product

2: G:Dot matrix type

3: The E-paper size:2.13inch:0213

4: The color of E-paper:

B: Black/White R: Black/White/Red Y: Black/White/Yellow

5: OT range: N: Normal L/S: Low temperature H/W: High temperature

6: Driver type: internal temperature sensor

7: FPC type

### 15. Inspection condition

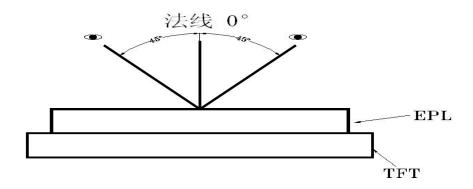
### 15.1 Environment

Temperature: 25±3 °C Humidity: 55±10%RH

#### 15.2 Illuminance

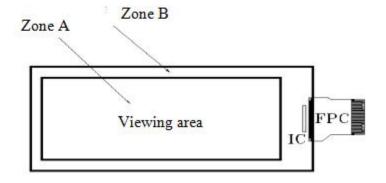
Brightness:1200~1500LUX;distance:20-30CM;Angle:Relate 45°surround.

### 15.3 Inspect method





### 15.4 Display area



## 15.5 Inspection standard

### 15.5.1 Electric inspection standard

|     |                               |   | <b>D</b> 0      |                            | <del>                                     </del> |
|-----|-------------------------------|---|-----------------|----------------------------|--|
| NO. | Item                          | Standard  | Defect<br>level | Method                     | Scope  |
| 1   | Display                       | Display complete Display uniform  | MA              |                            |  |
| 2   | Black/White spots             | D≤0.25mm, Allowed<br>0.25mm < D≤0.4mm on N≤3, and<br>Distance≥5mm<br>0.4mm < D Not Allow                      | MI              | Visual inspection          |  |
| 3   | Black/White spots (No switch) | L $\leq$ 0.6mm, W $\leq$ 0.2mm, N $\leq$ 1<br>L $\leq$ 2.0mm,W $>$ 0.2mm, Not Allow<br>L $>$ 0.6mm, Not Allow | . MI            | Visual/<br>Inspection card | Zone A   |
| 4   | Ghost image                   | Allowed in switching process  | MI              | Visual inspection          |  |



| 5 | Flash spots/<br>Larger FPL size                      | Flash spots in switching, Allowed FPL size larger than viewing area, Allowed | MI | Visual/<br>Inspection card | Zone A<br>Zone B |
|---|--|--|----|----------------------------|------------------|
| 6 | Display<br>wrong/Missing                             | All appointed displays are showed correct                                    | MA | Visual<br>inspection       | Zone A           |
| 7 | Short circuit/<br>Circuit break/<br>Display abnormal | Not Allow  |    |                            |                  |

### 15.5.2 Appearance inspection standard

| NO. | Item  | Standard   | Defect<br>level | Method                 | Scope            |
|-----|---|--|-----------------|------------------------|------------------|
|     | B/W spots<br>/Bubble/<br>Foreign bodies/<br>Dents | D= $(L+W)/2$ D $\leq 0.25$ mm, Allowed 0.25mm $\leq D\leq 0.4$ mm, N $\leq 3$ D $\geq 0.4$ mm, Not Allow   | MI              | Visual inspection      | Zone A           |
| 2   | Glass crack                                       | Not Allow  | MA              | Visual                 | Zone A<br>Zone B |
| 3   | Dirty   | Allowed if can be removed  | MI              | / Microscope           | Zone A<br>Zone B |
| 4   | Chips/Scratch/<br>Edge crown                      | $X \le 3$ mm, $Y \le 0.5$ mm And without affecting the electrode is permissible $2$ mm $\le X$ or $2$ mm $\le Y$ Not Allow $W \le 0.1$ mm, $L \le 5$ mm, No harm to the electrodes and $N \le 2$ allow | MI              | Visual<br>/ Microscope | Zone A<br>Zone B |



| 5  | TFT Cracks  | Not Allow   | MA | Visual<br>/ Microscope | Zone A<br>Zone B   |
|----|---|---|----|------------------------|--------------------|
| 6  | Dirty/ foreign<br>body                                    | Allowed if can be removed/ allow  | MI | Visual<br>/ Microscope | Zone A /<br>Zone B |
| 7  | FPC broken/ Goldfingers exidation/ scratch                | Not Allow   | MA | Visual<br>/ Microscope | Zone B             |
| 8  | TFT edge bulge<br>/TFT chromatic<br>aberration            | TFT edge bulge: $X \le 3$ mm, $Y \le 0.3$ mm Allowed TFT chromatic aberration :Allowed  | MI | Visual<br>/ Microscope | Zone A<br>Zone B   |
| 9  | PCB damaged/<br>Poor welding/<br>Curl                     | PCB (Circuit area) damaged Not<br>Allow<br>PCB Poor welding Not Allow<br>PCB Curl≤1%  |    |                        |                    |
| 10 | Edge glue height/<br>Edge glue bubble                     | Edge Adhesives H≤PS surface (Including protect film) Edge adhesives seep in≤1/2 Margin width Length excluding Edge adhesives bubble: bubble Width ≤1/2 Margin width; Length ≤0.5mm₀ n≤5 | MI | Visual<br>/ Ruler      | Zone B             |
| 11 | Protect film  | Surface scratch but not effect protect function, Allowed  |    | Visual<br>Inspection   |                    |
| 12 | Silicon glue  | Thickness ≤ PS surface(With protect film): Full cover the IC; Shape: The width on the FPC ≤ 0.5mm (Front) The width on the FPC≤1.0mm (Back) smooth surface, No obvious raised.          | MI | Visual<br>Inspection   |                    |
| 13 | Warp degree<br>(TFT substrate)                            | FPL<br>TFT<br>t≤2.0mm   | MI | Ruler                  |                    |
| 14 | Color difference<br>in COM area<br>(Silver point<br>area) | Allowed   |    | Visual<br>Inspection   |                    |



## 16.Packaging

#### DATE 2019.03.15 EPD PACKING INSTRUCTION DESIGN CHECKED DKE-QS. D-010 APPROVED P/N Customer Code Ref.P/N PKG Method Printing Surface Marks Pull Tape Bar. Code Туре DEPG0213 Blister None GLASS BACK None YES Marks instruction: Pull tape: print on the back of the product Contents: model+Lot# Packing Materials List 28PCS/LAYER, 20INNER BOX/CTN, TOTAL 560PCS/CTN. Model List Materials Q'ty Unit Barcode Instruction: corrugate Carton Piece BOX 7# (INNER) corrugate 2 Piece DEPG0213B Blister box PET 22 Piece EPE 20 Piece 289. 0\*261. 0\*T1. 8-2. 0 Thin foam Vaccum bag 450. 0\*590. 0\*0. 075 2 Piece Foam board DKE2251-10 **EPE** 3 16\*5\*T0.05 560 Piece pull tape Detail: Blister box should be rotated Blister box: TOTAL 10 LAYERS PER INNER BOX WITH ONE Empty blister box Vaccum bag Thin foam MORE EMPTY BLISTER ON THE TOP OF THE Blister PRODUCTS. ed with rubber bands Foam board . PUT IT INTO 7# INNER CARTON INNER BOX LABEL 7# INNER BOX PUT TWO 7# INNER BOXS INTO 7# CARTON Packing belt Quantity: 4\*7=28PCS rohs Label Epaper Identification